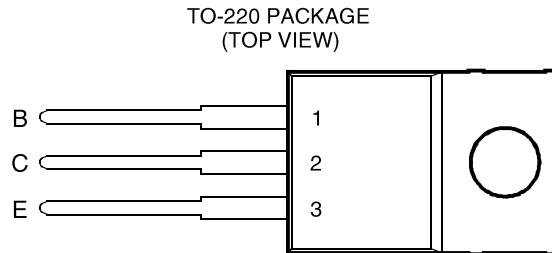




TIPL791, TIPL791A NPN SILICON POWER TRANSISTORS

- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability



Pin 2 is in electrical contact with the mounting base.

absolute maximum ratings **at 25°C case temperature (unless otherwise noted)**

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	850 1000	V
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	850 1000	V
Collector-emitter voltage ($I_B = 0$)	V_{CEO}	400 450	V
Emitter-base voltage	V_{EBO}	10	V
Continuous collector current	I_C	4	A
Peak collector current (see Note 1)	I_{CM}	8	A
Continuous device dissipation at (or below) 25°C case temperature	P_{tot}	75	W
Operating junction temperature range	T_j	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

TIPL791, TIPL791A NPN SILICON POWER TRANSISTORS

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS				MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$	Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2)	TIPL791 TIPL791A	400 450		V
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$		TIPL791		5	μA
		$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$		TIPL791A		5	
		$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL791		200	
		$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL791A		200	
I_{CEO}	Collector cut-off current	$V_{CE} = 400 \text{ V}$	$I_B = 0$		TIPL791		5	μA
		$V_{CE} = 450 \text{ V}$	$I_B = 0$		TIPL791A		5	
I_{EBO}	Emitter cut-off current	$V_{EB} = 10 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	(see Notes 3 and 4)		20	60	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.2 \text{ A}$	$I_C = 1 \text{ A}$				0.5	V
		$I_B = 0.5 \text{ A}$	$I_C = 2.5 \text{ A}$	(see Notes 3 and 4)			1.0	
		$I_B = 1 \text{ A}$	$I_C = 4 \text{ A}$				2.5	
		$I_B = 1 \text{ A}$	$I_C = 4 \text{ A}$	$T_C = 100^\circ\text{C}$			5.0	
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 0.2 \text{ A}$	$I_C = 1 \text{ A}$				1.0	V
		$I_B = 0.5 \text{ A}$	$I_C = 2.5 \text{ A}$	(see Notes 3 and 4)			1.2	
		$I_B = 1 \text{ A}$	$I_C = 4 \text{ A}$				1.4	
		$I_B = 1 \text{ A}$	$I_C = 4 \text{ A}$	$T_C = 100^\circ\text{C}$			1.3	
f_t	Current gain bandwidth product	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$		12		MHz
C_{ob}	Output capacitance	$V_{CB} = 20 \text{ V}$	$I_E = 0$	$f = 0.1 \text{ MHz}$		110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.66	°C/W

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †				MIN	TYP	MAX	UNIT
t_{sv}	$I_C = 4 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$	$I_{B(on)} = 0.8 \text{ A}$ (see Figures 1 and 2)					2	μs
t_{rv}							200	ns
t_{fi}							100	ns
t_{ti}							50	ns
t_{xo}							200	ns
t_{sv}	$I_C = 4 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$	$I_{B(on)} = 0.8 \text{ A}$ $T_C = 100^\circ\text{C}$ (see Figures 1 and 2)					2.5	μs
t_{rv}							400	ns
t_{fi}							200	ns
t_{ti}							50	ns
t_{xo}							600	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

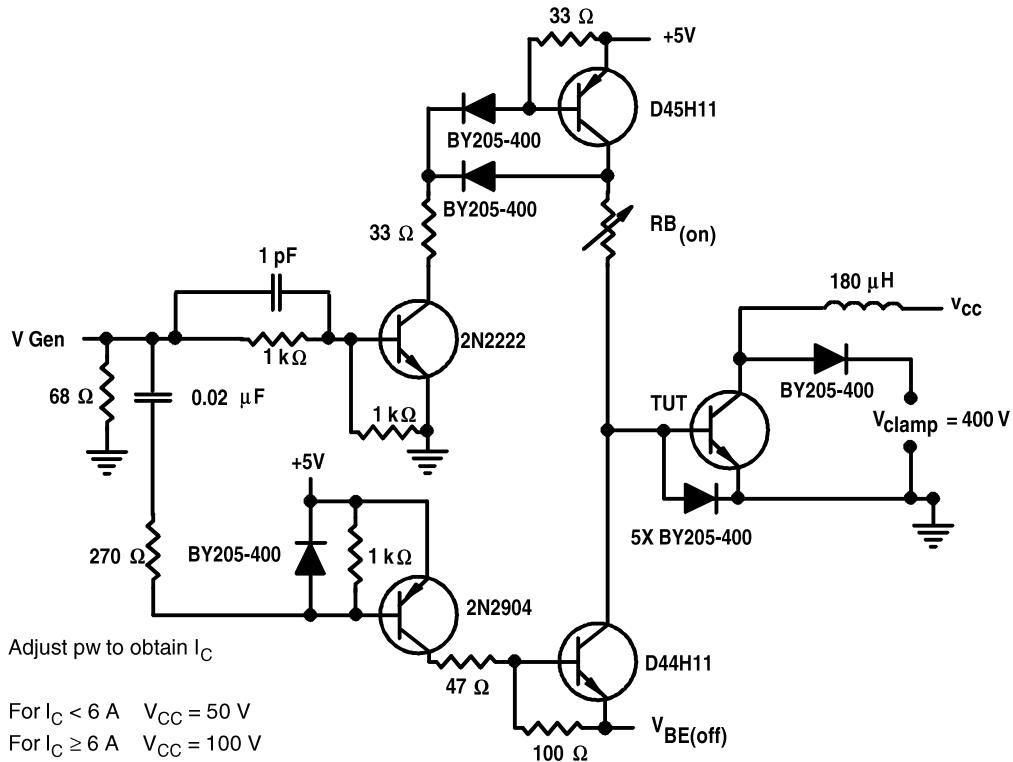
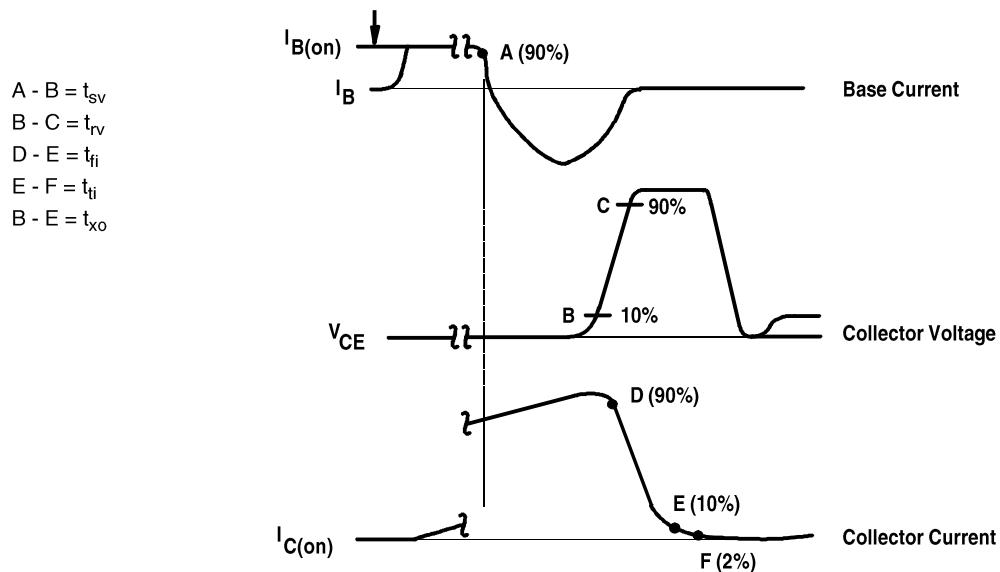


Figure 1. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15 \text{ ns}$, $R_{in} > 10 \Omega$, $C_{in} < 11.5 \text{ pF}$.
B. Resistors must be noninductive types.

Figure 2. Inductive-Load Switching Waveforms

TIPL791, TIPL791A NPN SILICON POWER TRANSISTORS

TYPICAL CHARACTERISTICS

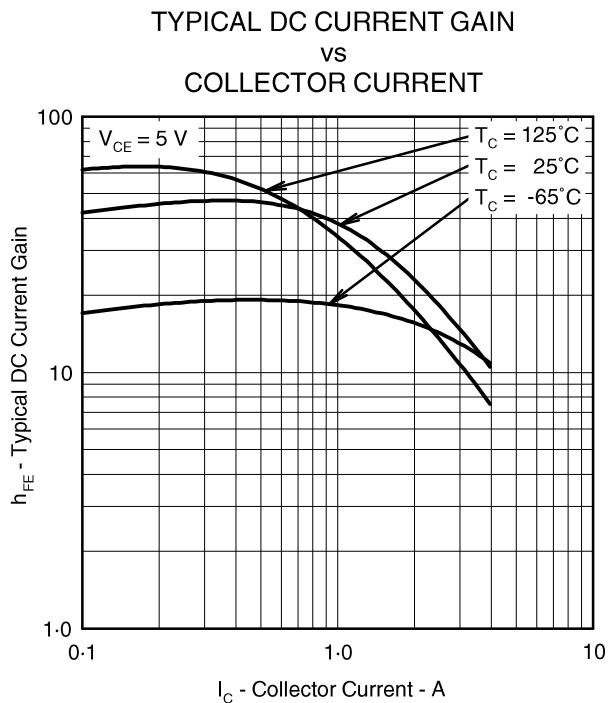


Figure 3.

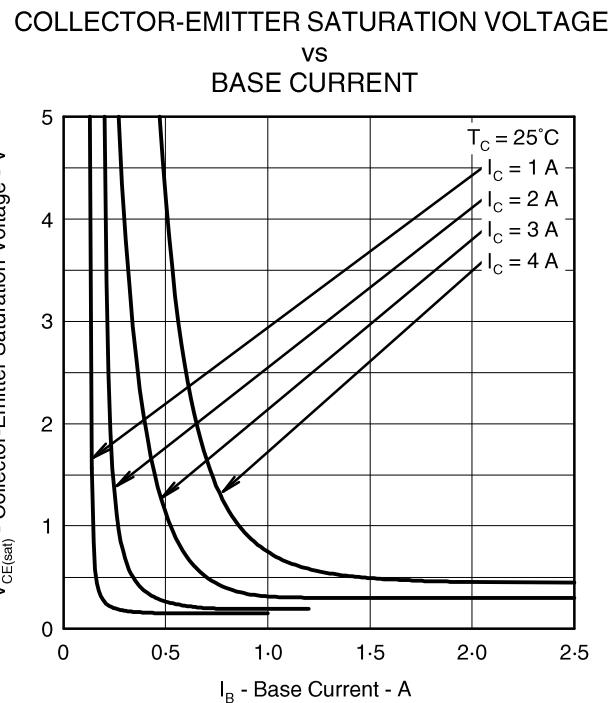


Figure 4.

MAXIMUM SAFE OPERATING REGIONS

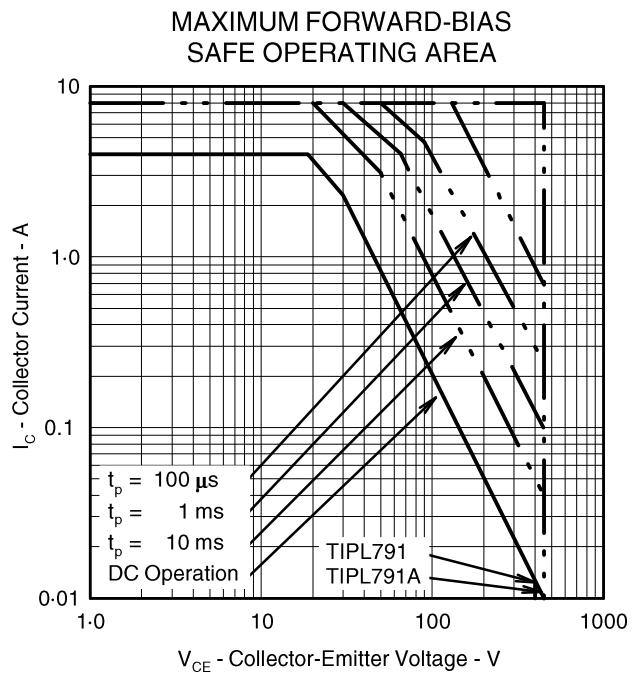
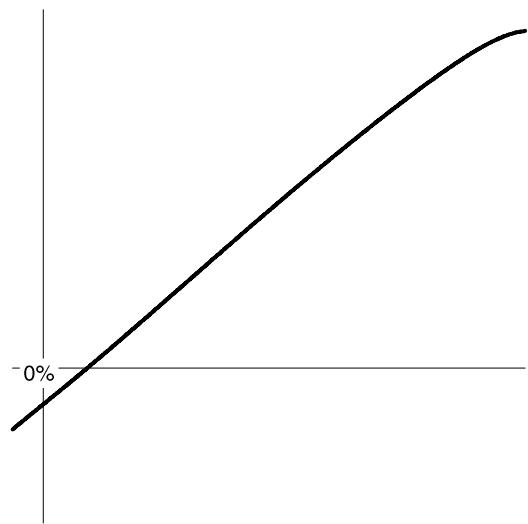


Figure 5.



TIPL791, TIPL791A NPN SILICON POWER TRANSISTORS

MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.

